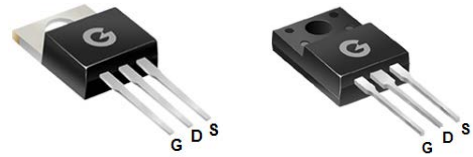


Features

- $R_{DS(ON)} = 2.5\Omega$ @ $V_{GS} = 10V$, $I_D = 2.5A$
- Improved dv/dt capability
- Fast switching

HF

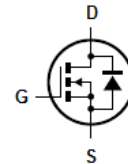


BL5N80

TO-220AB

BL5N80F

ITO-220AB



Mechanical Data

- Case: TO-220AB, ITO-220AB
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
BL5N80	TO-220AB	50pcs / Tube	5N80
BL5N80F	ITO-220AB	50pcs / Tube	5N80F

Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	V_{DSS}	800	V
Gate-to-Source Voltage	V_{GSS}	± 30	V
Continuous Drain Current ($T_C = 25^\circ\text{C}$)	I_D	5	A
Pulsed Drain Current	I_{DM}	20	A

Thermal Characteristics

Parameter	Symbol	BL5N80	BL5N80F	Unit
Power Dissipation ($T_C = 25^\circ\text{C}$)	P_D	110	45	W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	1.14	2.78	$^\circ\text{C/W}$
Operating Junction Temperature Range	T_J	-55 ~ +150		$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 ~ +150		$^\circ\text{C}$

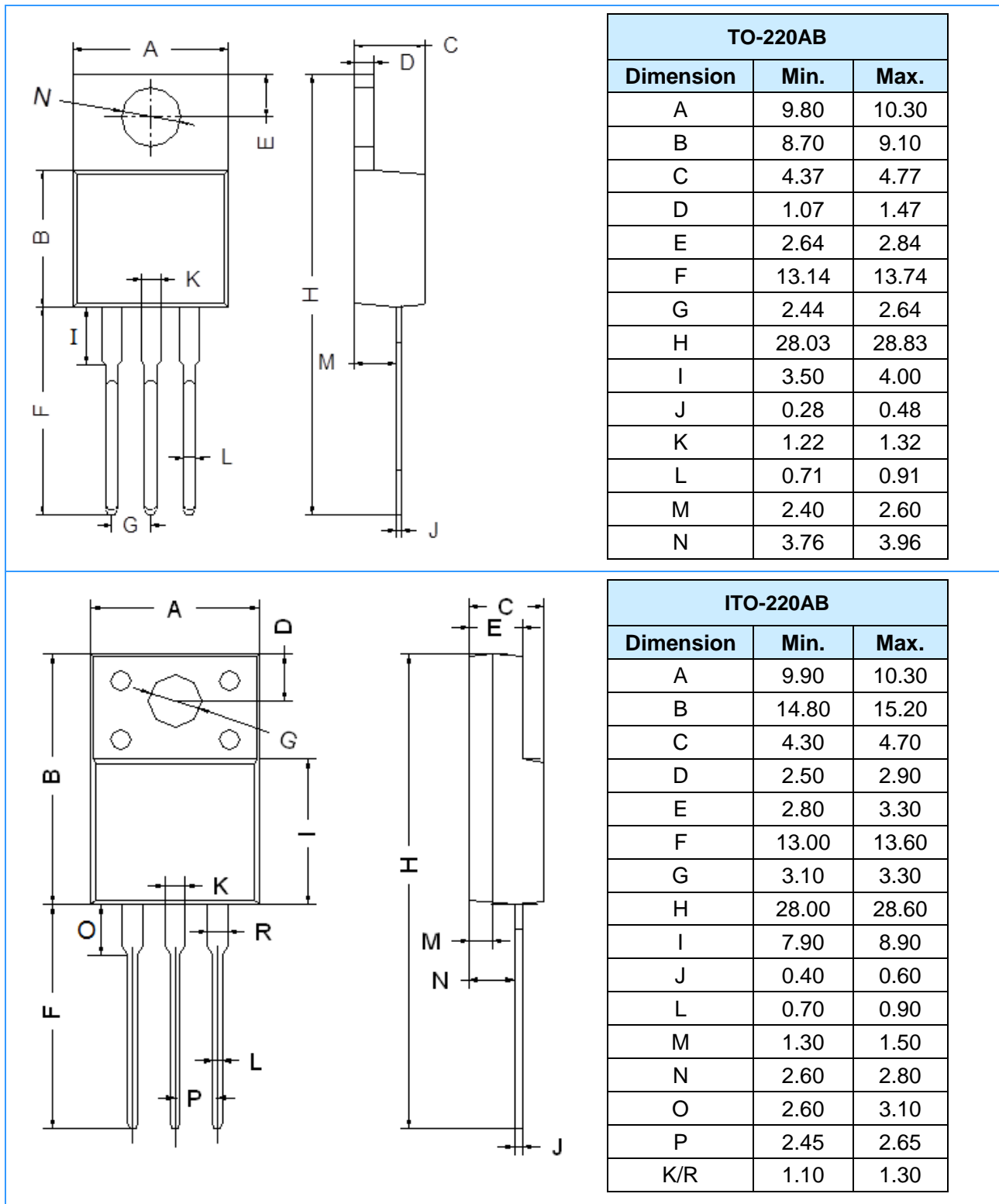
Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
V_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	800	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 800V, V_{GS} = 0V$	-	-	10	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	± 100	nA
On Characteristics *2						
$R_{DS(ON)}$	Static Drain-Source On-resistance	$V_{GS} = 10V, I_D = 2.5A$	-	1.6	2.5	Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	3	-	5	V
Dynamic Characteristics *3						
C_{ISS}	Input Capacitance	$V_{GS} = 0V$	-	1010	1310	pF
C_{OSS}	Output Capacitance	$V_{DS} = 25V$	-	90	115	
C_{RSS}	Reverse Transfer Capacitance	$f = 1.0MHz$	-	8	11	
Switching Characteristics *3						
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD} = 400V$ $R_L = 25\Omega$ $I_D = 5A$	-	26	60	ns
t_r	Turn-on Rise Time		-	65	140	
$t_{d(OFF)}$	Turn-Off Delay Time		-	47	105	
t_f	Turn-Off Fall Time		-	44	90	
Q_G	Total Gate-Charge	$V_{DD} = 640V, V_{GS} = 10V$ $I_D = 5A$	-	21	-	nC
Q_{GS}	Gate to Source Charge		-	6	-	
Q_{GD}	Gate to Drain (Miller) Charge		-	9	-	
Source-Drain Diode Characteristics						
V_{SD}	Diode Forward Voltage*1	$I_{SD} = 5A, V_{GS} = 0V$	-	-	1.4	V
I_S	Diode Continuous Forward Current	$T_C = 25^\circ\text{C}$	-	-	5	A

Notes:

- 1、 Surface mounted on FR4 board, $t \leq 10$ sec
- 2、 Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
- 3、 Guaranteed by design, not subject to production

Package Outline Dimensions (Unit: mm)



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